

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor dates sheds, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor dates sheds and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use on similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor and its officers, employees, subsidiaries, affliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any lay bed ON Semiconductor and its officers, employees, ween if such claim alleges that ON Semiconductor was negligent regarding the d



August 2010

FAN5341 Series Boost LED Driver with Integrated Schottky Diode and Single-Wire Digital Interface

Features

- Asynchronous Boost Converter
- Internal Schottky Diode

FAIRCHILD

SEMICONDUCTOR

- Up to 500mW Output Power
- Drives 3 to 5 LEDs in Series
- 2.7V to 5.5V Input Voltage Range
- Single-Wire Digital Control Interface to Set LED Brightness Levels
 - 32 Linear Steps
- 1.2MHz Fixed Switching Frequency
- Soft-Start Capability
- Input Under-Voltage Lockout (UVLO)
- Output Over-Voltage Protection (OVP)
- Short-Circuit Detection
- Thermal Shutdown (TSD) Protection
- Low Profile 6-lead 2.0 x 2.0 x 0.55mm UMLP Package

Applications

- Cellular Mobile Handsets
- Mobile Internet Devices
- Portable Media Plavers
- PDA, DSC, MP3 Players

Ordering Information

Part Number	Temperature Range	Package	Packing	
FAN5341UMPX	-40 to 85°C	6-lead, 2.0 x 2.0mm UMLP	Tape and Reel	

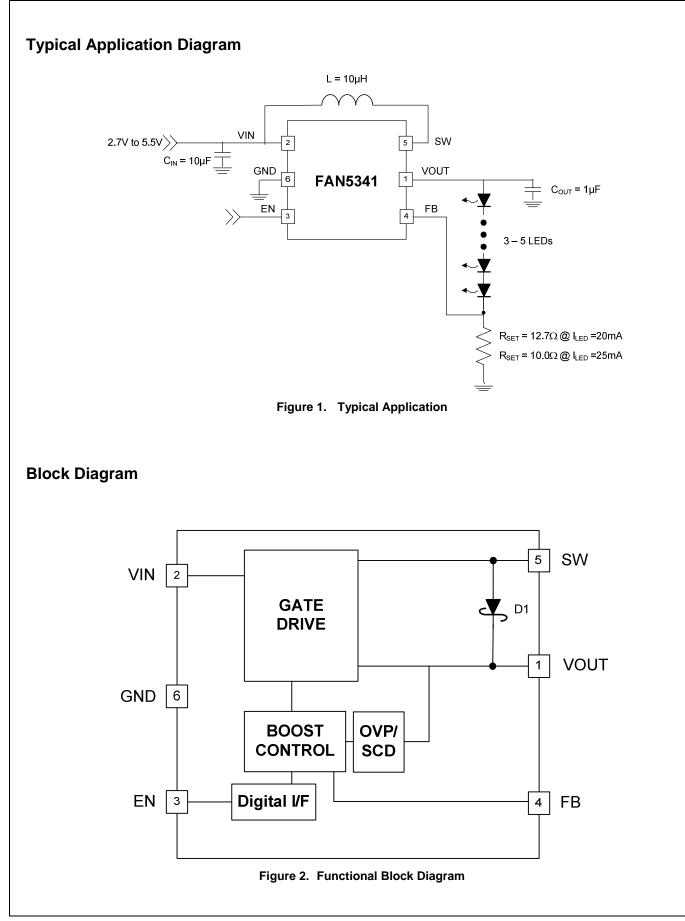
Description

The FAN5341 is an asynchronous constant-current LED driver capable of efficiently delivering up to 500mW to a string of up to five LEDs in series. Optimized for small form-factor applications, the 1.2MHz fixed switching frequency allows the use of small chip inductors and capacitors.

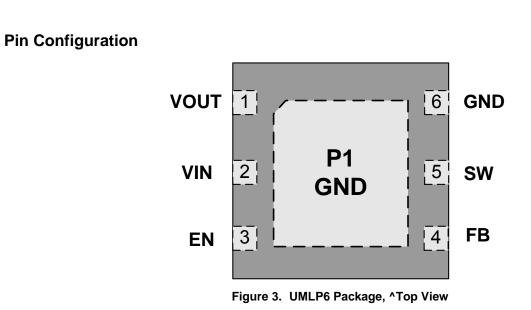
The FAN5341 uses a simple single-wire digital control interface to program the brightness levels of the LEDs in 32 linear steps by applying digital pulses.

For safety, the device features integrated over-voltage, overcurrent, short-circuit detection, and thermal-shutdown protection. In addition, input under-voltage lockout protection is triggered if the battery voltage is too low.

The FAN5341 is available in a very low profile, small formfactor 2mm x 2mm x 0.55mm 6-lead UMLP package that is green and RoHS compliant.







Pin Definitions

Pin #	Name	Description			
1	VOUT	Boost Output Voltage . Output of the boost regulator. Connect the LEDs to this pin. Connect C_{OUT} (Output Capacitor) to GND.			
2	VIN	Input Voltage. Connect to power source and decouple with C _{IN} to GND.			
3	EN	nable Brightness Control. Program dimming levels by driving pin with digital pulses.			
4	FB	'oltage Feedback . The boost regulator regulates this pin to 0.253V to control the LED string current. ie this pin to a current setting resistor (R_{SET}) between GND and the cathode of the LED string.			
5	SW	Switching node. Tie inductor L1 from VIN to SW pin.			
6	GND	Ground. Tie directly to a GND plane.			

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter			Max.	Units
V _{IN}	VIN	/IN		6.0	V
$V_{\text{FB}}, V_{\text{EN}}$	FB, EN Pins	B, EN Pins		V _{IN} + 0.3	V
Vsw	SW Pin		-0.3	22.0	V
V _{OUT}	VOUT Pin		-0.3	22.0	V
ESD	Electrostatic Discharge Protection Human Body Model per JESD22-A114 Level Charged Device Model per JESD22-C101		3.3		kV
ESD			2.0		
TJ	Junction Temperature		-40	+150	°C
T _{STG}	Storage Temperature		-65	+150	°C
TL	Lead Soldering Temperature, 10 Seconds			+260	°C

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Comments	Min.	Max.	Units
V _{IN}	VIN Supply Voltage		2.7	5.5	V
V _{OUT}	VOUT Voltage ⁽¹⁾		6.2	17.5	V
lout	VOUT Load Current	500mW Maximum Output Power	5	25	mA
T _A	Ambient Temperature		-40	+85	°C
TJ	Junction Temperature		-40	+125	°C

Note:

1. Application should guarantee that minimum and maximum duty-cycle should fall between 20-85% to meet the specified range

Thermal Properties

Junction-to-ambient thermal resistance is a function of application and board layout. This data is measured with four-layer 2s2p boards in accordance to JEDEC standard JESD51. Special attention must be paid not to exceed junction temperature $T_{J(max)}$ at a given ambient temperature T_A .

Symbol	Parameter		Units
θ_{JA}	Junction-to-Ambient Thermal Resistance, UMLP6 Package		°C/W

Electrical Specifications

 V_{IN} = 2.7V to 5.5V and T_A = -40°C to +85°C unless otherwise noted. Typical values are at T_A = 25°C and V_{IN} = 3.6V.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units	
Power Su	oplies		•	•			
I _{SD}	Shutdown Supply Current	$EN = GND, V_{IN} = 3.6V$		0.30	0.75	μA	
V _{UVLO}	Under-Voltage Lockout	V _{IN} Rising	2.10	2.35	2.60	60 V	
V UVLO	Threshold	V _{IN} Falling	1.90	2.15	2.40	v	
VUVHYST	Under-Voltage Lockout Hysteresis			250		mV	
EN: Enabl	e Pin						
VIH	HIGH-Level Input Voltage		1.2			V	
VIL	LOW-Level Input Voltage				0.4	V	
R _{EN}	EN Pull-Down Resistance		200	300	400	kΩ	
T _{LO}	EN Low Time for Dimming	V _{IN} = 3.6V; See Figure 14	0.5		300	μs	
Т _{ні}	Time Delay Between Steps	V _{IN} = 3.6V; See Figure 14	0.5			μs	
T _{SD}	EN Low, Shutdown Pulse Width	V _{IN} = 3.6V; from Falling Edge of EN	1			ms	
Feedback	and Reference						
V_{FB}	Feedback Voltage	I_{LED} = 20mA from -40°C to +85°C, 2.7V ≤ V _{IN} ≤ 5.5V	240	253	266	mV	
I _{FB}	Feedback Input Current	V _{FB} = 253mV		0.1	1.0	μA	
Power Ou	tputs						
5		V _{IN} = 3.6V, I _{SW} = 100mA		600			
R _{DS(ON)_Q1}	Boost Switch On-Resistance	V _{IN} = 2.7V, I _{SW} = 100mA		650		mΩ	
I _{SW(OFF)}	SW Node Leakage ⁽¹⁾	$EN = 0, V_{IN} = V_{SW} = V_{OUT} = 5.5V,$ $V_{LED} = 0$		0.1	2.0	μA	
I _{LIM-PK}	Boost Switch Peak Current Limit	V _{IN} = 3.6V		750		mA	
Oscillator							
\mathbf{f}_{SW}	Boost Regulator Switching Frequency		1.0	1.2	1.4	MHz	
Output an	d Protection						
V _{OVP}	Boost Output Over-Voltage Protection		18.0	18.9	21.0	v	
011	OVP Hysteresis			0.8			
V _{TLSC}	V _{OUT} Short Circuit Detection Threshold	V _{OUT} Falling		V _{IN} – 1.4		V	
V _{THSC}	V _{OUT} Short Circuit Detection Threshold	V _{OUT} Rising		V _{IN} – 1.2		V	
D _{MAX}	Maximum Boost Duty Cycle ^(2,3)		85			0/	
D _{MIN}	Minimum Boost Duty Cycle ^(2,3)	1			20	%	
T _{TSD}	Thermal Shutdown			150		°C	
T _{HYS}	Thermal Shutdown Hysteresis			35		°C	

Notes:

1. SW leakage current includes the leakage current of 2 internal switches; SW to GND and SW to VOUT.

2. Not tested in production and guaranteed by design.

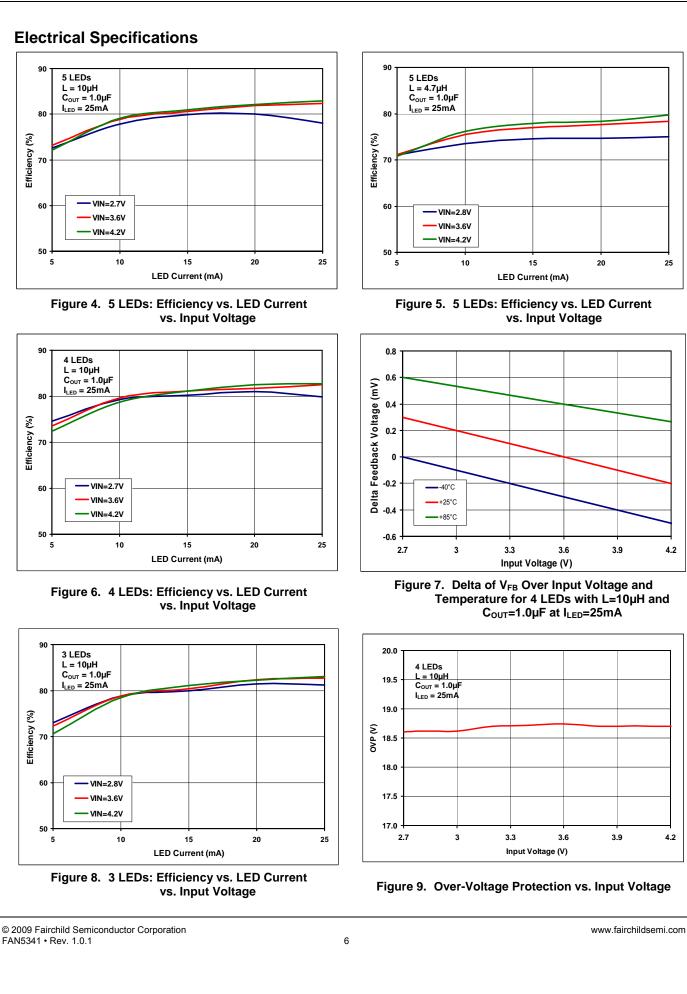
3. Application should guarantee that minimum and maximum duty cycle should fall between 20-85% to meet the specified range.

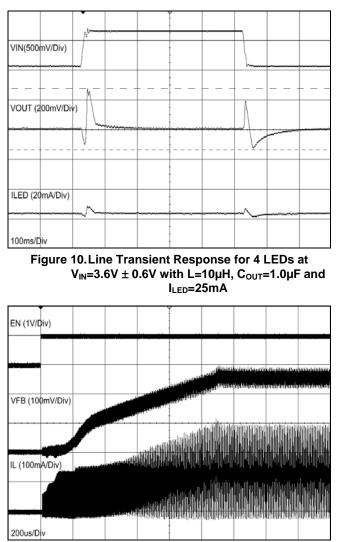


25

4.2

4.2





Electrical Specifications

Figure 12. Startup Waveform for Switch Voltage, Inductor Current, V_{FB} and EN for 4 LEDs at V_{IN}=3.6V \pm 0.6V with L=10µH, C_{OUT}=1.0µF and I_{LED}=25mA

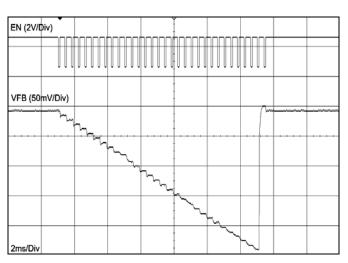


Figure 11.FAN5341 Dimming Operation at V_{IN} =3.6V for 4 LEDs with L=10µH, C_{OUT}=1.0µF and I_{LED}=25mA

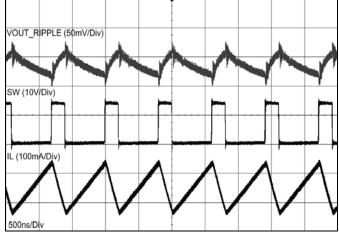


Figure 13. Steady-State Waveform for V_{OUT}, Switch Voltage and Inductor Current for 4 LEDs at V_{IN}=3.6V \pm 0.6V with L=10µH, C_{OUT}=1.0µF and I_{LED}=25mA

Circuit Description

Overview

The FAN5341 is an inductive current-mode boost serial LED driver that achieves LED current regulation by maintaining 0.253V across the R_{SET} resistor. The current through the LED string (I_{LED}) is therefore given by:

$$I_{LED} = \frac{0.253}{R_{SET}}$$
(1)

The voltage V_{OUT} is determined by the sum of the forward voltages across each LED, plus the voltage across $R_{\text{SET}},$ which is always 253mV.

Driving Five LEDs in Series

FAN5341 can drive five LEDs in series but, the forward voltage (V_F) of the LED MUST be less than 3.5V such that it remains under the over-voltage specification of 18.9V.

UVLO and Soft-Start

If EN has been low for more than 1ms, the IC may initiate a "cold start" soft-start cycle when EN rises, provided V_{IN} is above the UVLO threshold.

Digital Interface

The FAN5341 implements a single-wire digital interface to program the LED brightness to one of thirty-two (32) levels spaced in linear steps. With this single-wire solution, the

FAN5341 does not require the system processor to constantly supply a signal to it to drive the LEDs.

Digital Dimming Control

The FAN5341 starts driving the LEDs at the maximum brightness level. After startup, the control logic is ready to accept programming pulses to decrease the brightness level by the number of positive edges applied to the EN pin. Figure 14 shows the digital pulse dimming control.

Over-Current and Short-Circuit Detection

The boost regulator employs a cycle-by-cycle peak inductor current limit of ~750mA.

Over-Voltage / Open-Circuit Protection

If the LED string is an open circuit, FB remains at 0V and the output voltag continues to increase in the absence of an over-voltage protection (OVP) circuit. The FAN5341's OVP circuit disables the boost regulator when V_{OUT} exceeds 18.9V and continues to keep the regulator off until V_{OUT} drops below 18.1V.

Thermal Shutdown

When the die temperature exceeds 150°C, a reset occurs and remains in effect until the die cools to 125°C, at which time, the circuit is allowed to begin the soft-start sequence.

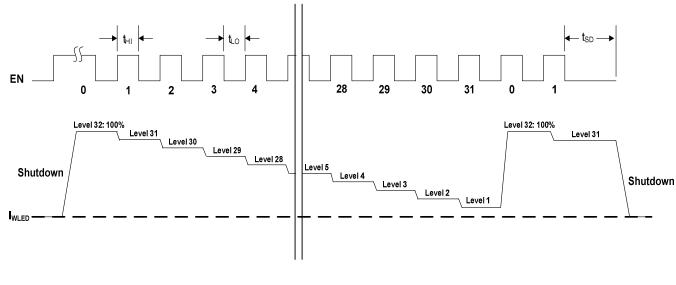


Figure 14. Digital Pulse-Dimming Control Diagram

Application Information

Inductor & Output Capacitor Selection

# of LEDs	Inductor (L)	Part Number	Manufacturer	Min Cout	Part Number	Manufacturer
		LQH43MN100K03	Murata			
	10.0µH	NLCV32T-100K-PFR	TDK	1.00µF	CV105X5R105K25AT	AVX/Kyocera
3, 4, 5		VLF3010AT-100MR49-1	TDK			
3, 4, 5	4.7µH	LQH43MN4R7K03	Murata			AVX/Kyocera
		NLCV32T-4R7M-PFR	TDK	1.00µF	CV105X5R105K25AT	
		LPF2010T-4R7M	ABCO			

Table 1. Recommended External Components

Component Placement and PCB Recomendations

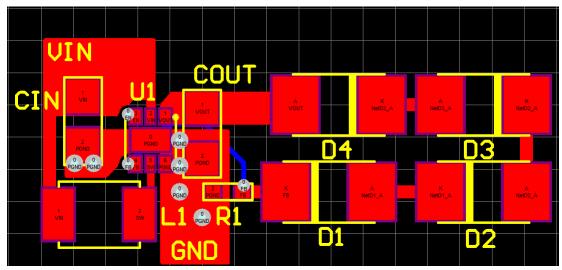


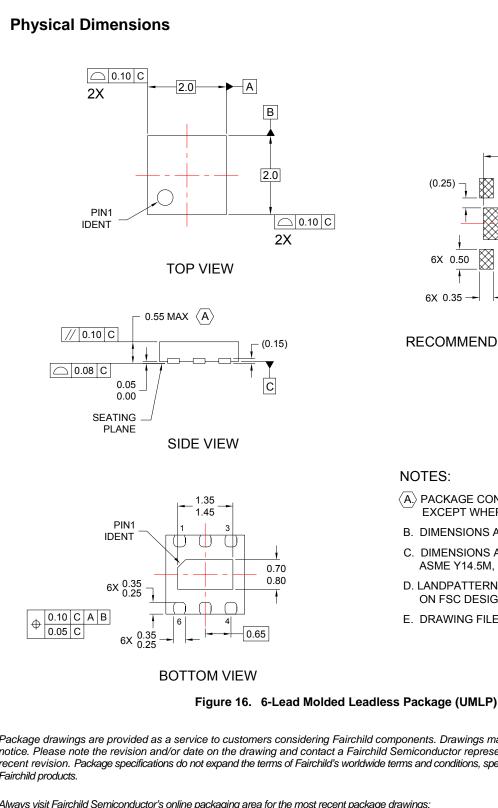
Figure 15. Recommended Component Placement

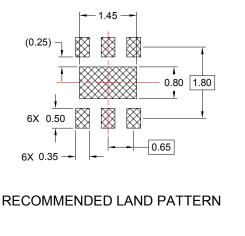
Input Capacitance

In a typical application, the input and output capacitors should be placed as close to the IC as possible; no additional capacitance is needed to ensure proper functionality. However, in a testing environment, where the FAN5341 is typically powered by a power supply with relatively long cables, an additional input capacitor (10μ F) may be needed to ensure stable functioning. This capacitor should be placed close to where the power supply cables attach to the FAN5341 evaluation board.

PCB Recommendations

- The inductor can be connected to VIN with vias through another layer if needed.
- The feedback pin should be connected back to the IC on a sub-layer.





- A. PACKAGE CONFORMS TO JEDEC MO-229 EXCEPT WHERE NOTED.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
- D. LANDPATTERN RECOMMENDATION IS BASED ON FSC DESIGN ONLY.
- E. DRAWING FILENAME: MKT-UMLP06Erev2.

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the waranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/packaging/.



SEMICONDUCTOR

TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

AccuPower™	F-PFS™
Auto-SPM™	FRFET®
Build it Now™	Global Powe
CorePLUS™	Green FPS™
CorePOWER™	Green FPS™
CROSSVOLT™	Gmax™
CTL™	GTO™
Current Transfer Logic™	IntelliMAX™
DEUXPEED®	ISOPLANAR
Dual Cool™	MegaBuck™
EcoSPARK [®]	MICROCOU
EfficientMa×™	MicroFET™
ESBC™	MicroPak™
F [®] .	MicroPak2™
7	MillerDrive™
Fairchild®	MotionMa×™
Fairchild Semiconductor®	Motion-SPM ¹
FACT Quiet Series™	OptoHiT™
FACT [®]	OPTOLOGIC
FAST [®]	OPTOPLAN/
FastvCore™	۲
FETBench™	
FlashWriter®*	PDP SPM™
FPS™	01 11

PEST RFET[®] lobal Power Resource^{s™} reen FPS™ reen FPS™ e-Series™ max TOTM telliMAX™ OPLANAR[™] egaBuck™ ICROCOUPLER** icroFET™ icroPak™ icroPak2™ illerDrive™ otionMa×™ otion-SPM™ ptoHiT™ PTOLOGIC[®] PTOPLANAR[®]

Power-SPM™ PowerTrench® PowerXS™ Programmable Active Droop™ QFET QS™ Quiet Series™ RapidConfigure™ **O**™ Saving our world, 1mW/W/kW at a time™ SignalWise™ SmartMax™ SMART START™ SPM® **STEALTH™** SuperFET™ SuperSOT™-3 SuperSOT™-6 SuperSOTM-8 SupreMOS® SyncFET™ Sync-Lock™

The Power Franchise Tranchise TinyBoost™ TinyBoost™ TinyCogic® TinyCopTO™ TinyPower™ TinyPower™

GENERAL



VisualMax™

XS™

* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN, FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- Life support devices or systems are devices or systems which, (a) are
 intended for surgical implant into the body or (b) support or sustain life,
 and (c) whose failure to perform when properly used in accordance
 with instructions for use provided in the labeling, can be reasonably
 expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition		
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		

www.fairchildsemi.com

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor: FAN5341UMPX